TOSHIBA Photocoupler PHOTORELAY

TLP3121

Measurement Instruments
Logic Testers / Memory Testers
Board Testers / Scanners

The TOSHIBA TLP3121 Mini-flat photorelay is a small-outline photorelay, suitable for surface-mount assembly. The TLP3121 consists of a GaAs infrared-emitting diode optically coupled to a photo-MOS FET and housed in a 4-pin package.

Features

• 4 pin SOP (2.54SOP4) : 2.1 mm high, 2.54 mm pitch

• 1-Form-A

Peak off-state voltage : 80 V (min)
 Trigger LED current : 4 mA (max)
 ON-State current : 350 mA (max)
 ON-state resistance : 1.2 Ω (max)
 OFF-state capacitance : 40 pF (max)
 Isolation voltage : 1500 Vrms (min)

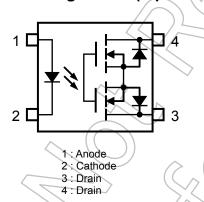
• UL approved: UL1577, File No.E67349

• cUL approved :CSA Component Acceptance Service

No. 5A, File No.E67349

Weight: 0.1 g (typ.)

Pin configuration (top view)



Absolute Maximum Ratings (Ta = 25°C)

	Characteristic	Symbol	Rating	Unit
	Forward current	lF	50	mA
	Forward current derating (Ta ≥ 25°C)	ΔI _F /°C	-0.5	mA/°C
Ω	Reverse voltage	V _R	5	V
FE	Diode power dissipation	P _D	50	mW
	Diode power dissipation derating (Ta ≥25°C)	∆P _D /°C	-0.5	mW/°C (
	Junction temperature	Tj	125	°C
	OFF-state output terminal voltage	V _{OFF}	80	(v//
	ON-state current	I _{ON}	350	mA
Detector	ON-state current derating (Ta ≥ 25°C)	ΔI _{ON} /°C	-3.5	mA/°C
Dete	Output power dissipation	PO	147	mW
	Output power dissipation derating (Ta ≥ 25°C)	ΔP _o /°C	-1.47	mW/°C
	Junction temperature	Tj	125	°C
Stora	ge temperature range	T _{stg}	-40 to 125	°C
Oper	ating temperature range	T _{opr}	-20 to 85	°C <
Lead	soldering temperature (10 s)	T _{sol}	260	°C)°
Isolat	tion voltage (AC, 1 minute, R.H. \leq 60%) (Note 1)	BVs	1500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two-terminal device : LED side pins shorted together, and detector side pins shorted together.

Recommended Operating Conditions

Characteristic	Symbol	Min	Тур.	Max	Unit
Supply voltage	V _{DD}))	1	64	٧
Forward current	E	5	_	30	mA
On-state current	JON	_	_	350	mA
Operating temperature	T _{opr}	25	_	60	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Individual Electrical Characteristics (Ta = 25°C)

	Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	V _F	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I _R	V _R = 5 V	_	_	10	μΑ
	Capacitance between terminals	C _T	V _F = 0 V, f = 1 MHz	_	15	_	pF
ector	Off-state current	loff	V _{OFF} = 30 V, Ta = 50°C	ı	200	1000	pА
Detector	Capacitance between terminals	C _{OFF}	V = 0 V, f = 100 MHz		30	40	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I _{FT}	I _{ON} = 350 mA	_	1	4	mA
Return LED current	I _{FC}	I _{OFF} = 10 μA	0.2	_	_	mA
On-state resistance	R _{ON}	$I_{ON} = 350 \text{ mA}, I_F = 5 \text{ mA}$	4	1.0	1.2	Ω

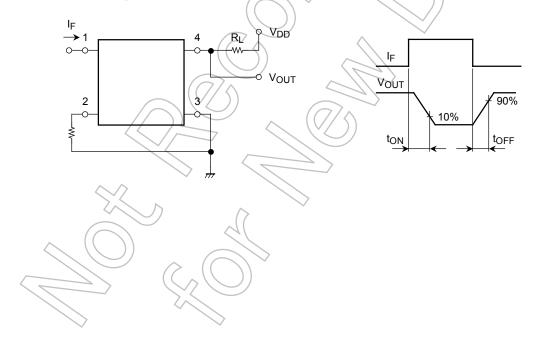
Isolation Characteristics (Ta = 25°C)

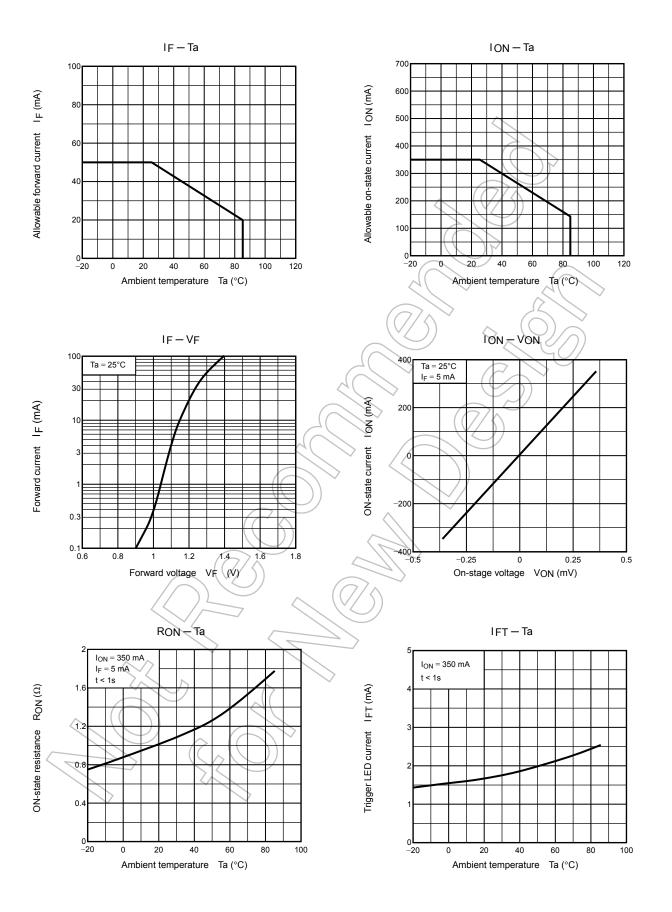
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	CS	V _S = 0 V, f = 1 MHz)	0.8	_	pF
Isolation resistance	R _S	V _S = 500 V, R.H. ≤ 60%	5 × 10 ¹⁰	10 ¹⁴	_	Ω
	BVS	AC, 1 minute	1500	-(/	Vrms
Isolation voltage		AC, 1 second (in oil)	_	3000	(VIIIIS
		DC, 1 minute (in oil)	-	3000	>-	Vdc

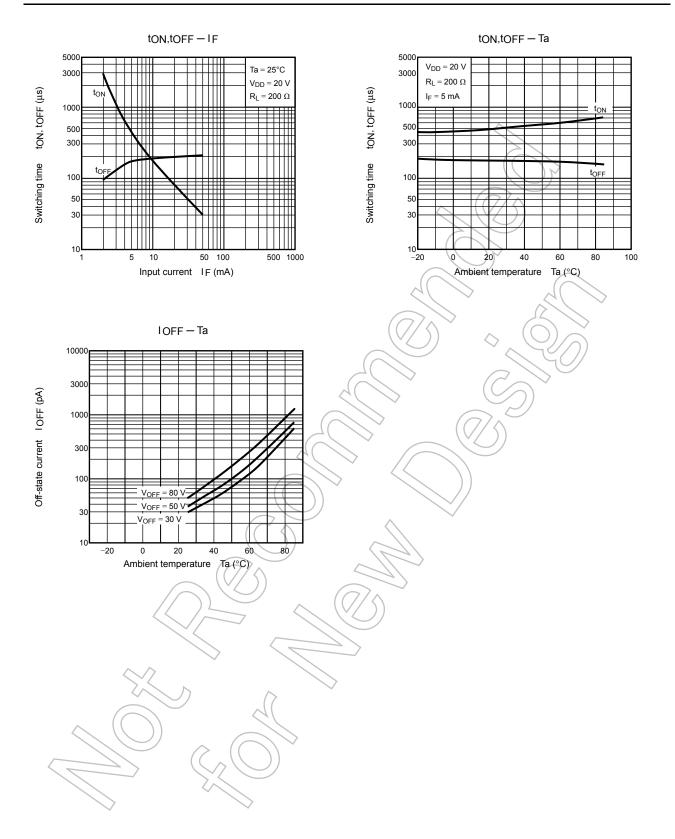
Switching Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	t _{ON}	$R_L = 200 \Omega$ (Note 2)	Z/A	300	500	6
Turn-off time	t _{OFF}	$V_{DD} = 20 \text{ V}, I_F = 5\text{mA}$	\mathcal{G}	300	500	μS

Note 2 : switching time test circuit







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6

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